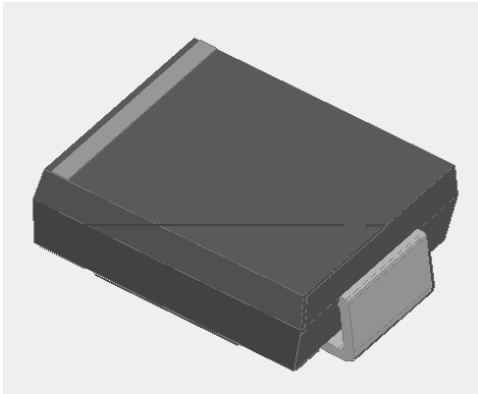


Surface Mount High Efficient Rectifier

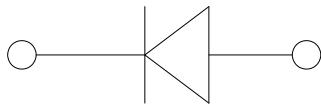


Typical Applications

For use in high frequency rectification of power supplies, inverters, converters, and freewheeling diodes for consumer and telecommunication.

Mechanical Data

- Package: DO-214AB (SMC)
- Molding compound meets UL 94 V-0 flammability rating, RoHS-compliant, halogen-free
- Terminals: Tin plated leads, solderable per J-STD-002 and JESD22-B102
- Polarity: Color band denotes the cathode end



■Maximum Ratings (T_a=25 Unless otherwise specified)

PARAMETER	SYMBOL	UNIT	HS3A	HS3B	HS3D	HS3F	HS3G	HS3J	HS3K	HS3M
Device marking code			HS3A	HS3B	HS3D	HS3F	HS3G	HS3J	HS3K	HS3M
Maximum Repetitive Peak Reverse Voltage	VRRM	V	50	100	200	300	400	600	800	1000
Maximum RMS Voltage	VRMS	V	35	70	140	210	280	420	560	700
Maximum DC blocking Voltage	VDC	V	50	100	200	300	400	600	800	1000
Average Rectified Output Current @60Hz sine wave, Resistance load, TL (FIG.1)	I _O	A	3.0							
Forward Surge Current (Non-repetitive) @60Hz Half-sine wave, 1 cycle, T _j =25	I _{FSM}	A	100							
Forward Surge Current (Non-repetitive) @1ms, square wave, 1 cycle, T _j =25			200							
Current squared time @1ms≤t≤8.3ms T _j =25	I ² t	A ² s	41.5							
Storage temperature	T _{stg}		-55 ~ +150							
Junction temperature	T _j		-55 ~ +150							



HS3A THRU HS3M

■Electrical Characteristics $T_a=25$ Unless otherwise specified

PARAMETER	SYMBOL	UNIT	TEST CONDITIONS	HS3A	HS3B	HS3D	HS3F	HS3G	HS3J	HS3K	HS3M
Maximum instantaneous forward voltage	V _F	V	I _{FM} =3.0A	1.0			1.3		1.7		
Maximum reverse recovery time	t _{rr}	ns	I _F =0.5A, I _R =1.0A, I _{rr} =0.25A	50					75		
Maximum DC reverse current at rated DC blocking voltage	I _R	μA	T _J =25	5							
			T _J =125	100							
Typical junction capacitance	C _J	pF	Measured at 1MHz and Applied Reverse Voltage of 4.0 V.D.C	60			40		24		

■Thermal Characteristics $T_a=25$ Unless otherwise specified

PARAMETER	SYMBOL	UNIT	HS3A	HS3B	HS3D	HS3F	HS3G	HS3J	HS3K	HS3M
Typical Thermal resistance	$R_{\theta J-A(1)}$	/W	48							
	$R_{\theta J-L(1)}$		15							
	$R_{\theta J-C(1)}$		12							

Note(1)

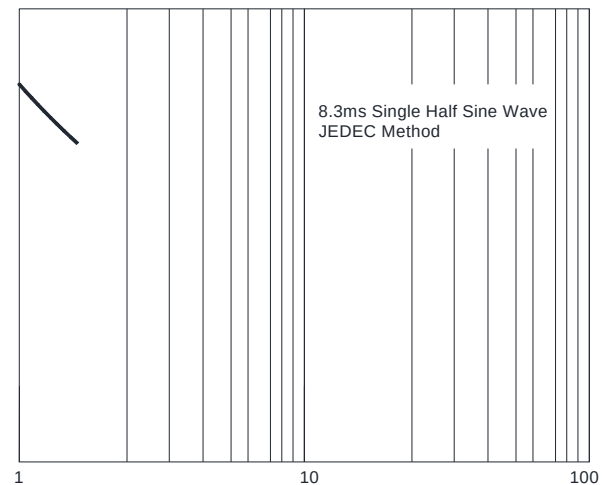
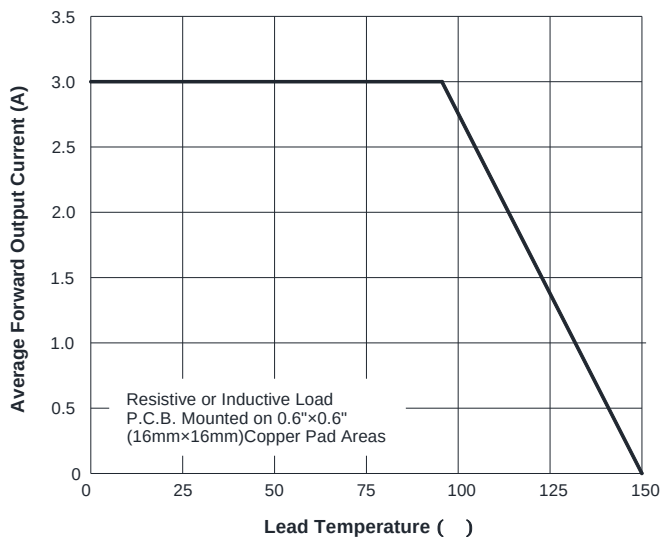
Thermal resistance from junction to ambient and from junction to lead mounted on P.C.B. with 0.6" x 0.6" (16 mm x16 mm) copper pad areas

■Ordering Information (Example)

PREFERRED P/N	PACKAGE CODE	UNIT WEIGHT(g)	MINIMUM PACKAGE(pcs)	INNER BOX QUANTITY(pcs)	OUTER CARTON QUANTITY(pcs)	DELIVERY MODE
HS3A~HS3M	F1	Approximate 0.248	3000	/	42000	13" reel

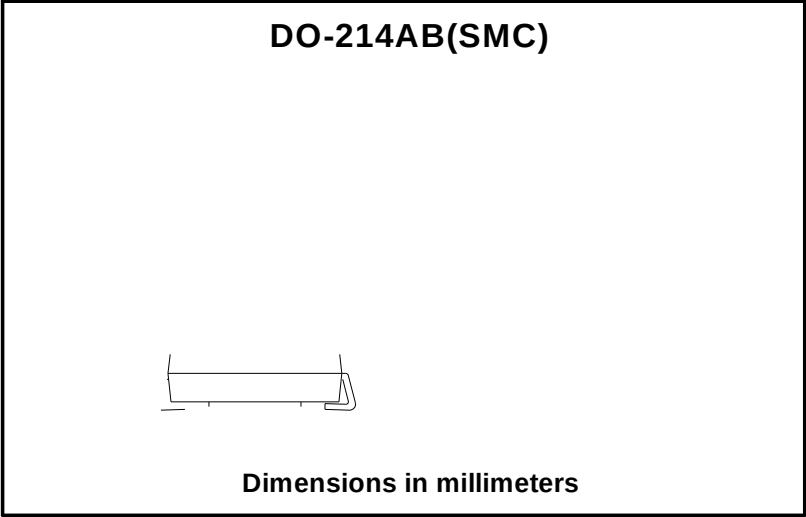
■ Characteristics(Typical)

FIG.1: I_o -TL Curve





■ Outline Dimensions

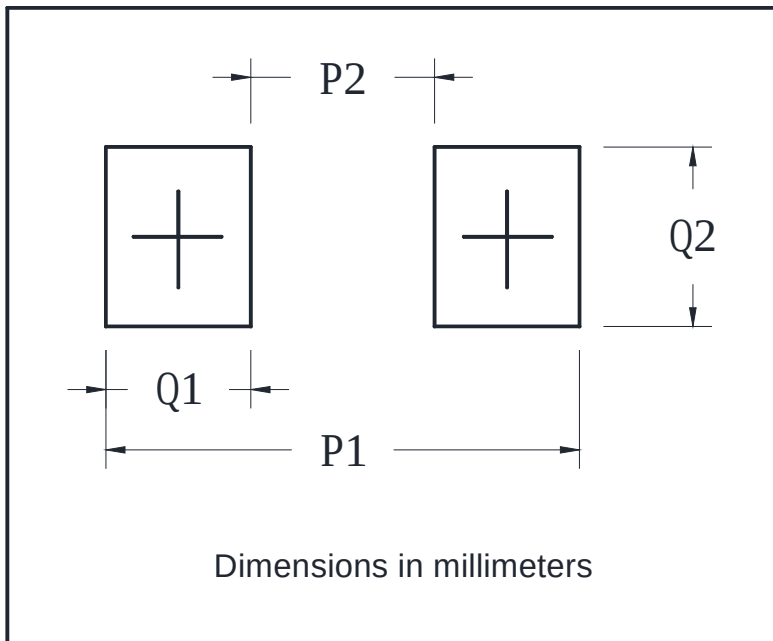


DO-214AB (SMC)		
Dim	Min	Max
A	6.60	7.11
B	2.85	3.27
C	5.59	6.22
D	7.75	8.13
E	1.99	2.61
F	0.15	0.31
G	0.76	1.52
H	0.05	0.20



HS3A THRU HS3M

y Suggested pad layout



DO-214AB (SMC)	
Dim	Min
P1	9.9
P2	3.84
Q1	3.03
Q2	3.82



HS3A THRU HS3M

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